



DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **A Process Of Making A Compound By Forming A Polymer From A Template Drug** the specification of which:
(check one)

☒ [X] is attached hereto;
☐ [] was filed on _____ as Application Serial Number _____
and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. § 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

PRIOR FOREIGN APPLICATION(S)

PRIORITY CLAIMED

N/A
(Number) (Country) (Day/Month/Year Filed)

☐ [] ☐ []
Yes No

N/A
(Number) (Country) (Day/Month/Year Filed)

☐ [] ☐ []
Yes No

N/A
(Number) (Country) (Day/Month/Year Filed)

☐ [] ☐ []
Yes No

I hereby claim the benefit under 35 U.S.C. §119(e) of any United States provisional application(s) listed below:

(Application Serial No.)
Abandoned)

60/009,593

(Filing Date)

1/4/96

(Status - Patented, Pending, or

Pending

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. § 1.56, which became available between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)
Abandoned)

(Filing Date)

(Status - Patented, Pending, or

(Application Serial No.)
Abandoned)

(Filing Date)

(Status - Patented, Pending, or

I hereby appoint the following attorney(s) and/or agents, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

FULL NAME OF FIRST INVENTOR Jon A. Wolff

INVENTOR'S SIGNATURE /Jon A. Wolff/ DATE _____

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INVENTOR'S SIGNATURE / James E. Hagstrom/ DATE _____

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INVENTOR'S SIGNATURE / Vladimir G. Budker/ DATE _____

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FULL NAME OF SIXTH INVENTOR Lisa J. Hanson

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